

MC14569B

**Programmable Divide-By-N
Dual 4-Bit Binary/BCD
Down Counter**

The MC14569B is a programmable divide-by-N dual 4-bit binary or BCD down counter constructed with MOS P-channel and N-channel enhancement mode devices (complementary MOS) in a monolithic structure.

This device has been designed for use with the MC14568B phase comparator/counter in frequency synthesizers, phase-locked loops, and other frequency division applications requiring low power dissipation and/or high noise immunity.

- Speed-up Circuitry for Zero Detection
- Each 4-Bit Counter Can Divide Independently in BCD or Binary Mode
- Can be Cascaded With MC14568B, MC14522B or MC14526B for Frequency Synthesizer Applications
- All Outputs are Buffered
- Schmitt Triggered Clock Conditioning

MAXIMUM RATINGS* (Voltages Referenced to V_{SS})

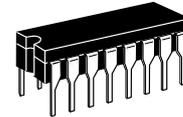
Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage	- 0.5 to + 18.0	V
V_{in}, V_{out}	Input or Output Voltage (DC or Transient)	- 0.5 to $V_{DD} + 0.5$	V
I_{in}, I_{out}	Input or Output Current (DC or Transient), per Pin	± 10	mA
P_D	Power Dissipation, per Package†	500	mW
T_{stg}	Storage Temperature	- 65 to + 150	°C
T_L	Lead Temperature (8-Second Soldering)	260	°C

* Maximum Ratings are those values beyond which damage to the device may occur.

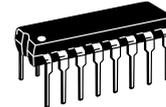
† Temperature Derating:

Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C

Ceramic "L" Packages: - 12 mW/°C From 100°C To 125°C



L SUFFIX
CERAMIC
CASE 620



P SUFFIX
PLASTIC
CASE 648



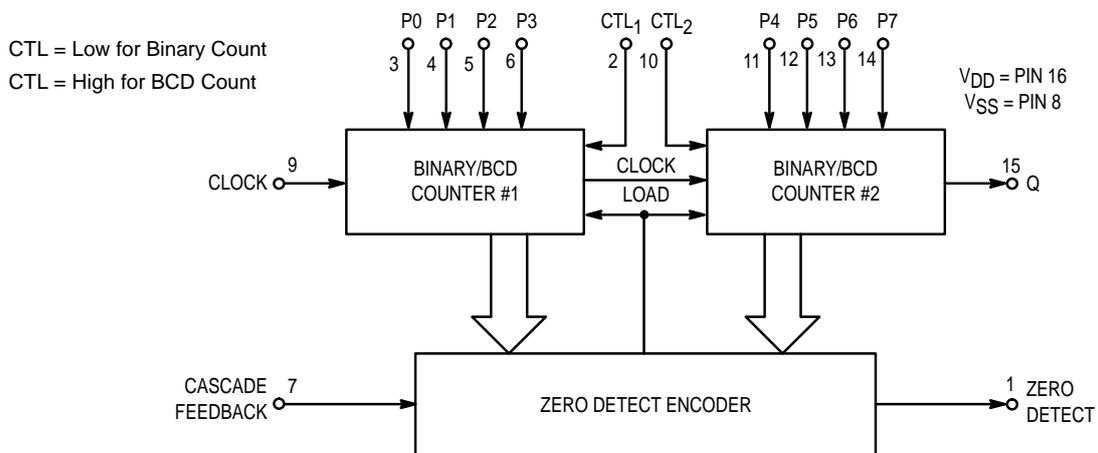
DW SUFFIX
SOIC
CASE 751G

ORDERING INFORMATION

MC14XXXBCP Plastic
MC14XXXBCL Ceramic
MC14XXXBDW SOIC

$T_A = - 55^\circ$ to 125°C for all packages.

BLOCK DIAGRAM



ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V _{DD} Vdc	- 55°C		25°C			125°C		Unit	
			Min	Max	Min	Typ #	Max	Min	Max		
Output Voltage V _{in} = V _{DD} or 0 V _{in} = 0 or V _{DD}	"0" Level "1" Level	V _{OL}	5.0	—	0.05	—	0	0.05	—	0.05	Vdc
			10	—	0.05	—	0	0.05	—	0.05	
15			—	0.05	—	0	0.05	—	0.05	—	
		V _{OH}	5.0	4.95	—	4.95	5.0	—	4.95	—	Vdc
			10	9.95	—	9.95	10	—	9.95	—	
			15	14.95	—	14.95	15	—	14.95	—	
Input Voltage (V _O = 4.5 or 0.5 Vdc) (V _O = 9.0 or 1.0 Vdc) (V _O = 13.5 or 1.5 Vdc) (V _O = 0.5 or 4.5 Vdc) (V _O = 1.0 or 9.0 Vdc) (V _O = 1.5 or 13.5 Vdc)	"0" Level "1" Level	V _{IL} V _{IH}	5.0	—	1.5	—	2.25	1.5	—	1.5	Vdc
			10	—	3.0	—	4.50	3.0	—	3.0	
			15	—	4.0	—	6.75	4.0	—	4.0	
Output Drive Current (V _{OH} = 2.5 Vdc) (V _{OH} = 4.6 Vdc) (V _{OH} = 9.5 Vdc) (V _{OH} = 13.5 Vdc) (V _{OL} = 0.4 Vdc) (V _{OL} = 0.5 Vdc) (V _{OL} = 1.5 Vdc)	Source Sink	I _{OH} I _{OL}	5.0	- 3.0	—	- 2.4	- 4.2	—	- 1.7	—	mAdc
			5.0	- 0.64	—	- 0.51	- 0.88	—	- 0.36	—	
			10	- 1.6	—	- 1.3	- 2.25	—	- 0.9	—	
			15	- 4.2	—	- 3.4	- 8.8	—	- 2.4	—	
			5.0	0.64	—	0.51	0.88	—	0.36	—	mAdc
			10	1.6	—	1.3	2.25	—	0.9	—	
			15	4.2	—	3.4	8.8	—	2.4	—	
Input Current	I _{in}	15	—	±0.1	—	±0.00001	±0.1	—	±1.0	μAdc	
Input Capacitance (V _{in} = 0)	C _{in}	—	—	—	—	5.0	7.5	—	—	pF	
Quiescent Current (Per Package)	I _{DD}	5.0	—	5.0	—	0.005	5.0	—	150	μAdc	
		10	—	10	—	0.010	10	—	300		
		15	—	20	—	0.015	20	—	600		
Total Supply Current**† (Dynamic plus Quiescent, Per Package) (C _L = 50 pF on all outputs, all buffers switching)	I _T	5.0 10 15	I _T = (0.58 μA/kHz) f + I _{DD} I _T = (1.20 μA/kHz) f + I _{DD} I _T = (1.95 μA/kHz) f + I _{DD}							μAdc	

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

**The formulas given are for the typical characteristics only at 25°C.

†To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) Vfk$$

where: I_T is in μA (per package), C_L in pF, V = (V_{DD} - V_{SS}) in volts, f in kHz is input frequency, and k = 0.001.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range V_{SS} ≤ (V_{in} or V_{out}) ≤ V_{DD}. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

SWITCHING CHARACTERISTICS* ($C_L = 50 \text{ pF}$, $T_A = 25^\circ\text{C}$)

Characteristic	Symbol	V_{DD} Vdc	All Types			Unit	
			Min	Typ #	Max		
Output Rise Time	t_{TLH}	5.0	—	100	200	ns	
		10	—	50	100		
		15	—	40	80		
Output Fall Time	t_{THL}	5.0	—	100	200	ns	
		10	—	50	100		
		15	—	40	80		
Turn-On Delay Time Zero Detect Output	t_{PLH}	5.0	—	420	700	ns	
		10	—	175	300		
		15	—	125	250		
		Q Output	5.0	—	675	1200	ns
			10	—	285	500	
			15	—	200	400	
Turn-Off Delay Time Zero Detect Output	t_{PHL}	5.0	—	380	600	ns	
		10	—	150	300		
		15	—	100	200		
		Q Output	5.0	—	530	1000	ns
			10	—	225	400	
			15	—	155	300	
Clock Pulse Width	t_{WH}	5.0	300	100	—	ns	
		10	150	45	—		
		15	115	30	—		
Clock Pulse Frequency	f_{cl}	5.0	—	3.5	2.1	MHz	
		10	—	9.5	5.1		
		15	—	13.0	7.8		
Clock Pulse Rise and Fall Time	t_{TLH}, t_{THL}	5.0	NO LIMIT			μs	
		10					
		15					

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

SWITCHING WAVEFORMS

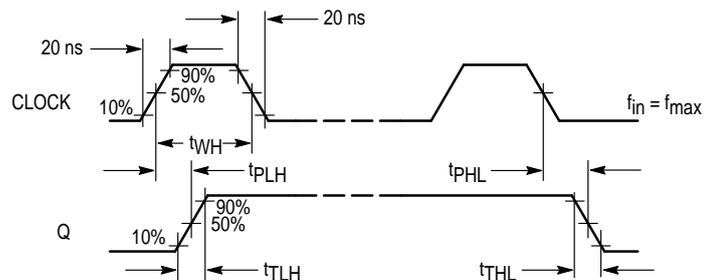


Figure 1.

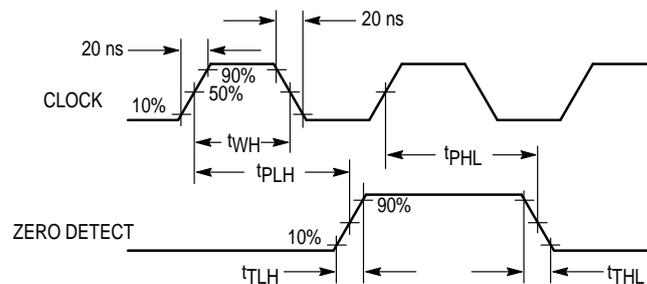


Figure 2.

PIN DESCRIPTIONS

INPUTS

P0, P1, P2, P3 (Pins 3, 4, 5, 6) — Preset Inputs. Programmable inputs for the least significant counter. May be binary or BCD depending on the control input.

P4, P5, P6, P7 (Pins 11, 12, 13, 14) — Preset Inputs. Programmable inputs for the most significant counter. May be binary or BCD depending on the control input.

Clock (Pin 9) — Preset data is decremented by one on each positive transition of this signal.

OUTPUTS

Zero Detect (Pin 1) — This output is normally low and goes high for one clock cycle when the counter has decremented to zero.

Q (Pin 15) — Output of the last stage of the most significant counter. This output will be inactive unless the preset input P7 has been set high.

CONTROLS

Cascade Feedback (Pin 7) — This pin is normally set high. When low, loading of the preset inputs (P0 through P7) is inhibited, i.e., P0 through P7 are “don’t cares.” Refer to Table 1 for output characteristics.

CTL₁ (Pin 2) — This pin controls the counting mode of the least significant counter. When set high, counting mode is BCD. When set low, counting mode is binary.

CTL₂ (Pin 10) — This pin controls the counting mode of the most significant counter. When set high, counting mode is BCD. When set low, counting mode is binary.

SUPPLY PINS

V_{SS} (Pin 18) — Negative Supply Voltage. This pin is usually connected to ground.

V_{DD} (Pin 16) — Positive Supply Voltage. This pin is connected to a positive supply voltage ranging from 3.0 volts to 18.0 volts.

OPERATING CHARACTERISTICS

The MC14569B is a programmable divide-by-N dual 4-bit down counter. This counter may be programmed (i.e., preset) in BCD or binary code through inputs P0 to P7. For each counter, the counting sequence may be chosen independently by applying a high (for BCD count) or a low (for binary count) to the control inputs CTL₁ and CTL₂.

The divide ratio N (N being the value programmed on the preset inputs P0 to P7) is automatically loaded into the counter as soon as the count 1 is detected. Therefore, a division ratio of one is not possible. After N clock cycles, one

pulse appears on the Zero Detect output. (See Timing Diagram.) The Q output is the output of the last stage of the most significant counter (See Tables 1 through 5, Mode Controls.)

When cascading the MC14569B to the MC14568B, MC14522B or the MC14526B, the Cascade Feedback input, Q, and Zero Detect outputs must be respectively connected to “0”, Clock, and Load of the following counter. If the MC14569B is used alone, Cascade Feedback must be connected to V_{DD}.

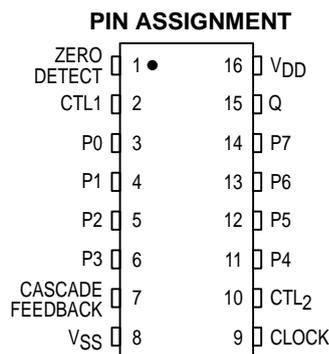
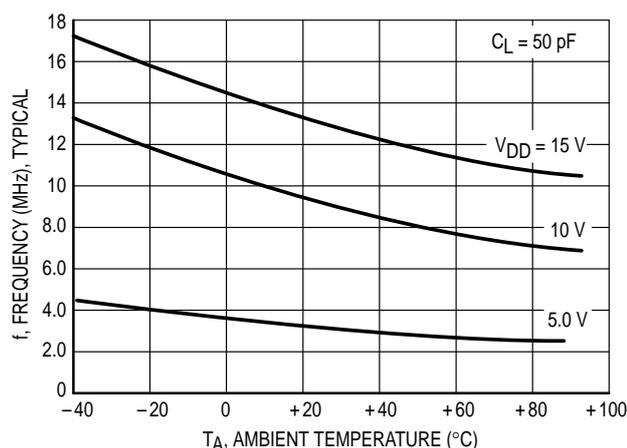


Table 4. Mode Controls (CTL₁ = Low, CTL₂ = High, Cascade Feedback = High)

Preset Values								Divide Ratio		Comments
P7	P6	P5	P4	P3	P2	P1	P0	Zero Detect	Q	
0	0	0	0	0	0	0	0	160	160	Max Count Illegal State Min Count
0	0	0	0	0	0	0	1	X	X	
0	0	0	0	0	0	1	0	2	X	
0	0	0	0	0	0	1	1	3	X	
.	X	
.	X	
.	X	
0	0	0	0	1	1	1	1	15	X	
0	0	0	1	0	0	0	0	16	X	
.	X	
.	X	
0	0	0	1	1	1	1	1	31	X	
0	0	1	0	0	0	0	0	32	X	
.	X	
.	X	
0	0	1	1	0	0	0	0	48	X	
.	
.	
0	1	0	0	0	0	0	0	64	X	
.	
.	
0	1	0	1	0	0	0	0	80	X	
.	
.	
0	1	1	1	0	0	0	0	112	X	
.	
.	
1	0	0	0	0	0	0	0	128	128	
.	
.	
1	0	0	1	0	0	0	0	144	144	
.	
.	
1	0	0	1	1	1	1	1	159	159	
27	26	25	24	23	22	21	20			Bit Value
128	64	32	16	8	4	2	1			
Counter #2 BCD				Counter #1 Binary						Counting Sequence

X = No Output (Always Low)

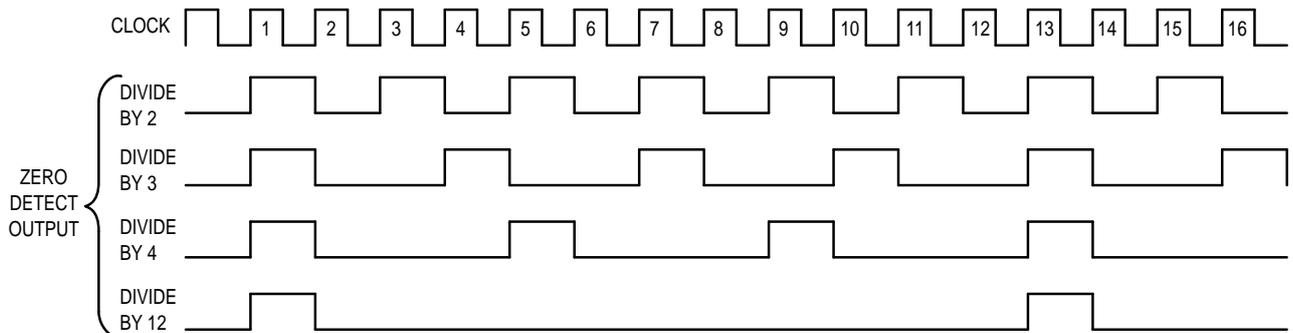
Q Output Active
↓

Table 5. Mode Controls (CTL₁ = High, CTL₂ = High, Cascade Feedback = High)

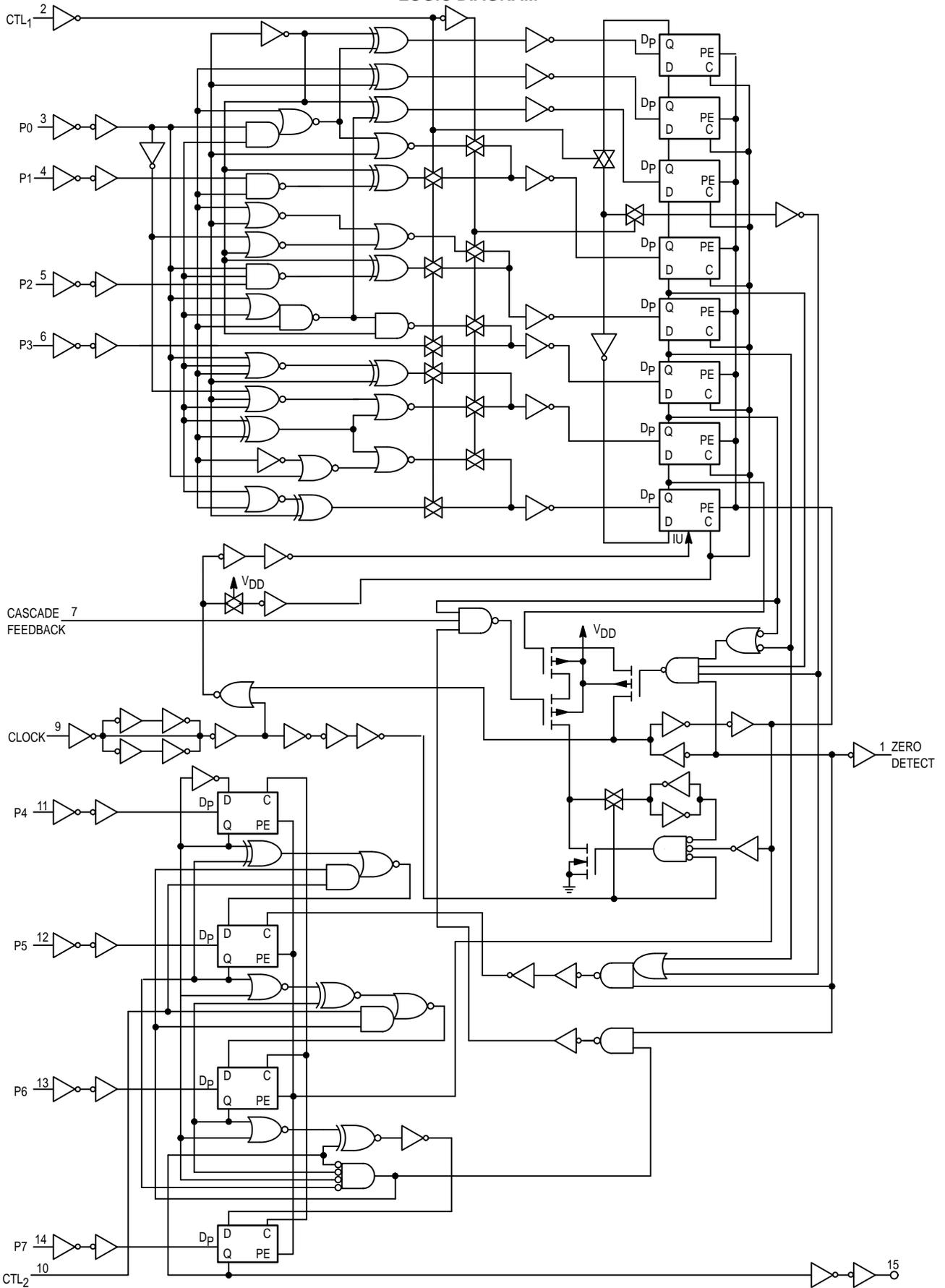
Preset Values								Divide Ratio		Comments	
P7	P6	P5	P4	P3	P2	P1	P0	Zero Detect	Q		
0	0	0	0	0	0	0	0	100	100	Max Count illegal state Min Count	
0	0	0	0	0	0	0	1	X	X		
0	0	0	0	0	0	1	0	2	X		
0	0	0	0	0	0	1	1	3	X		
.	X		
.	X		
.	X		
0	0	0	0	1	0	0	1	9	X		
0	0	0	1	0	0	0	0	10	X		
.	X		
.	X		
0	0	1	1	0	0	0	0	30	X		
.	X		
.	X		
0	1	0	0	0	0	0	0	40	X		
.	X		
.	X		
0	1	0	1	0	0	0	0	50	X		
.	X		
.	X		
0	1	1	1	0	0	0	0	70	X		
.	X		
.	X		
1	0	0	0	0	0	0	0	80	80	Q Output Active ↓	
.		
.		
1	0	0	1	0	0	0	0	90	90		
.		
.		
1	0	0	1	1	0	0	1	99	99		
80	40	20	10	8	4	2	1				Bit Value
Counter #2 BCD				Counter #1 BCD							Counting Sequence

X = No Output (Always Low)

TIMING DIAGRAM MC14569B



LOGIC DIAGRAM



TYPICAL APPLICATIONS

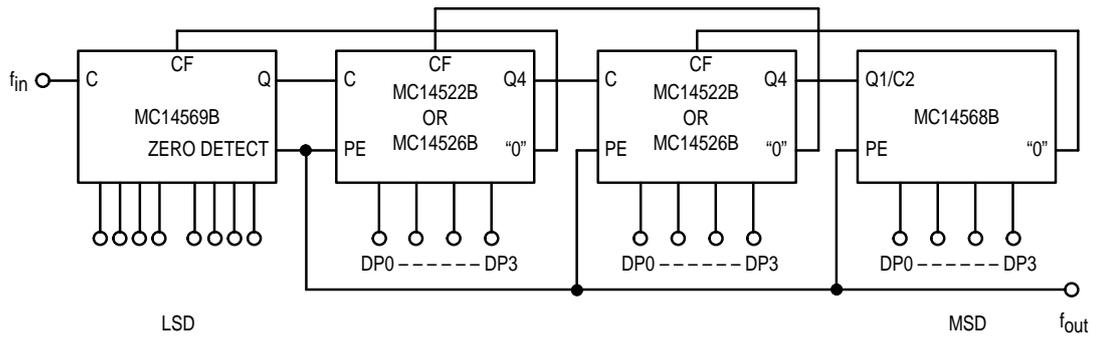


Figure 3. Cascading MC14568B and MC14522B or MC14526B with MC14569B

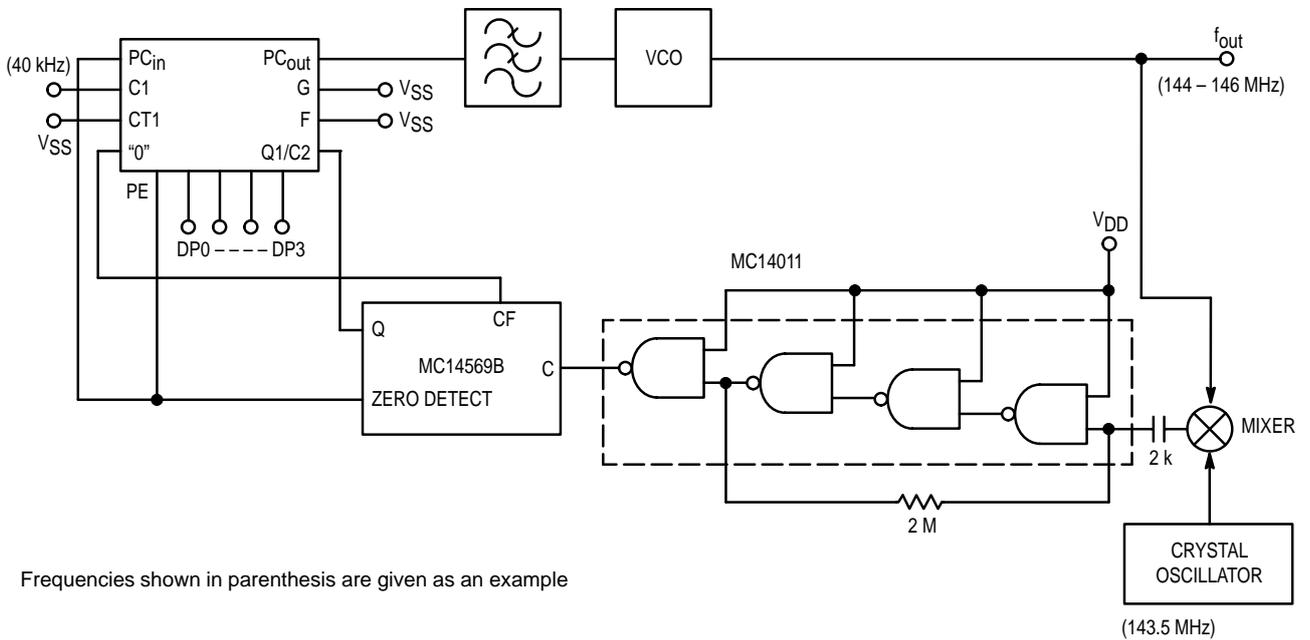
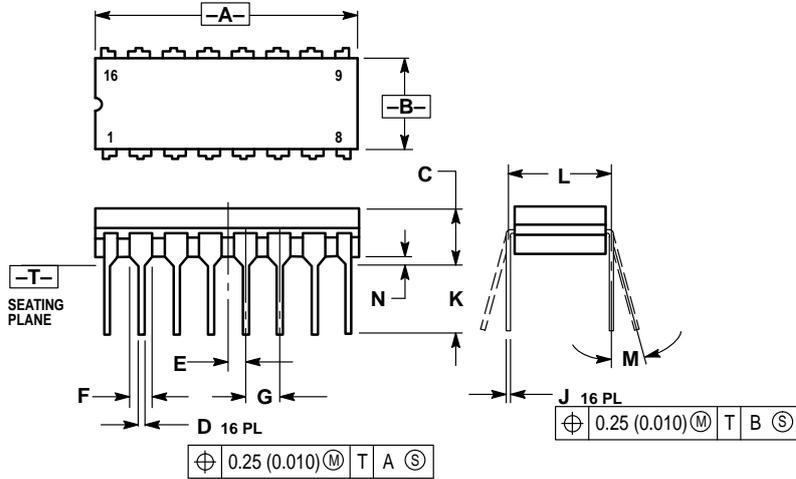


Figure 4. Frequency Synthesizer with MC14568B and MC14569B Using a Mixer (Channel Spacing 10 kHz)

OUTLINE DIMENSIONS

L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE V

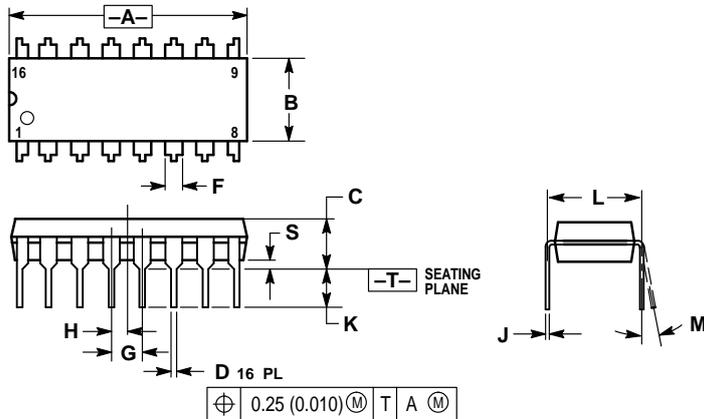


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



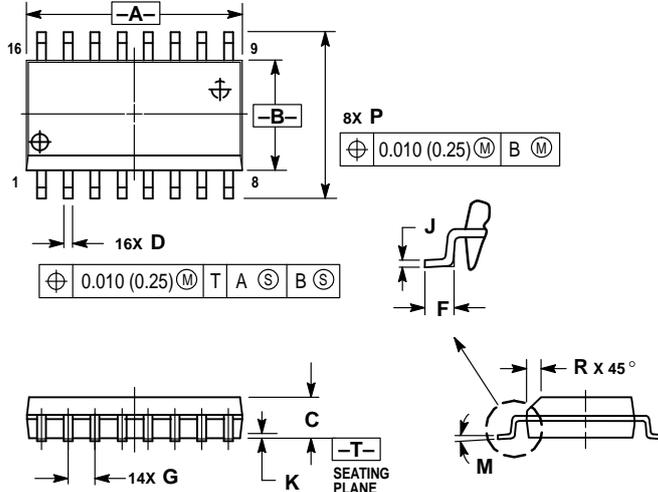
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

OUTLINE DIMENSIONS

DW SUFFIX PLASTIC SOIC PACKAGE CASE 751G-02 ISSUE A



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

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MC14569B/D

